

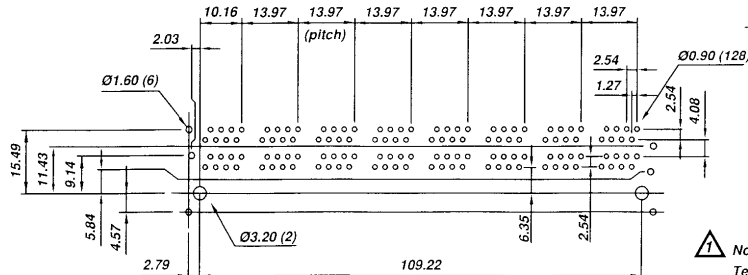
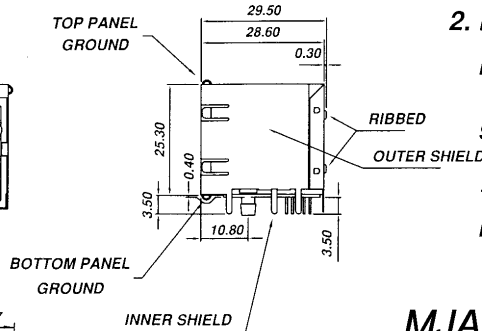
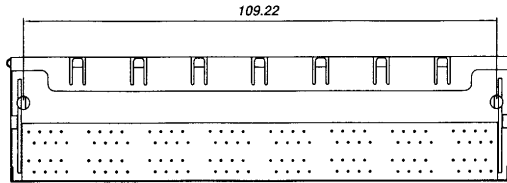
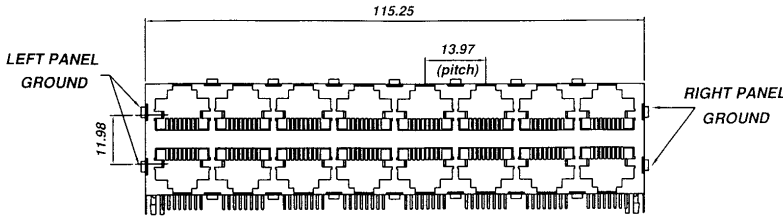
SPECIFICATION :

1. Electrical Char.

- Insulation Resistance : 500M-Ohm Min.
- Contact Resistance : 20milli-Ohm Max.
- Rating Current : 1.5A Max.
- Rating Voltage : 120V AC
- Dielectric Voltage : 1,000 Vrms 60 Sec. Min.

2. Physical char.

- Housing : PBT Glass Filled (UL 94V-0)
- Color : Black Color
- Spring Wire : 0.35mm Thickness Phosphor Bronze
- Gold Plating Over Nickel.
- Temperature Range : - 25 /+90 Deg C
- Durability : 500 Mating cycles Min.



⚠ Note : Total Cd(cadmium) Content< 5PPM(mg/kg)
Test Method : EN1122:2001 Method (ICP-AES)
: Total Pb(Lead) Content< 100PPM(mg/kg)
Test Method : US EPA3050B (ICP-AES)

PCB LAYOUT
(Top View)

MJA9-8828-G3S

F=8p8c		Gold plated	1=15u , 3=50u
			2=30u , 4= 6 u

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TITLE
DOUBLE DECK GANG PCB JACK
UL & cUL FILE NO. E131820

MODULAR JACKS ASSY FOR
MJA9-8828-G3S

SCALE SIZE DWG. NO.9600 SERIES

DWG. NO. **AS600030-L**

NOT SCALED DRAWING	TOLERANCE UNLESS OTHERWISE NOTICE	INCH	MM	DR.	DATE
	LINEAR $\frac{MM}{INCH}$	00±0.01 000±0.005 0000±0.002	00±0.25 000±0.13 0000±0.05	Steven CK D Johnn APP'D Billy	DEC-23 '04 DEC-23 '04 DEC-23 '04
	ANGLE+0°30'	RADIL	+0.40 -0.15		